TITLE OF INVENTION: A COMPOSITE INTERMEDIARY DEVICE USING VERTICAL PROBE FOR WAFER TESTING

ABSTRACT OF THE DISCLOSURE

The invention relates to a composite intermediary device using vertical probe for wafer testing, having a Wi-Fi hotspot and translation device, using the oscillating heat dissipation module to improve the heat dissipation performance, and then using the phase change temperature regulating micro airbag to achieve the effect of intelligent temperature adjustment, integrating the traditional Wi-Fi hotspot machine and translation machine, and becoming a compound machine of Wi-Fi hotspot and translation device, it is combined with the smart phone, using the artificial intelligence chip, parallel computing and processing, so that the working efficiency of the Wi-Fi hotspot and translation device is greatly improved, and then has the function of integrating the functions of Wi-Fi hotspot machine, translator machine and smart phone into a Composite intermediary device using vertical probe for wafer testing that is easy to carry abroad.

FIG. 2